

深圳市博合数码科技有限公司

Shenzhen Bohoo Digi-Tech Co.,Ltd

SPECIFICATION

MODEL: BH-4K03-E

Rev: 1.0

Part Number:

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Approved by		
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REVISION HISTORY

Rev	DATE	PAGE	DESCRIPTION	AUTHOR
1.0	21.3.3	All	First issued	Danny Xu
1.0	21.6.4	2	Update Product picture 更新图片	Danny Xu
1.0	24.5.24	2	Update Product picture 更新图片	

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1. GENERAL DESCRIPTION （概述）

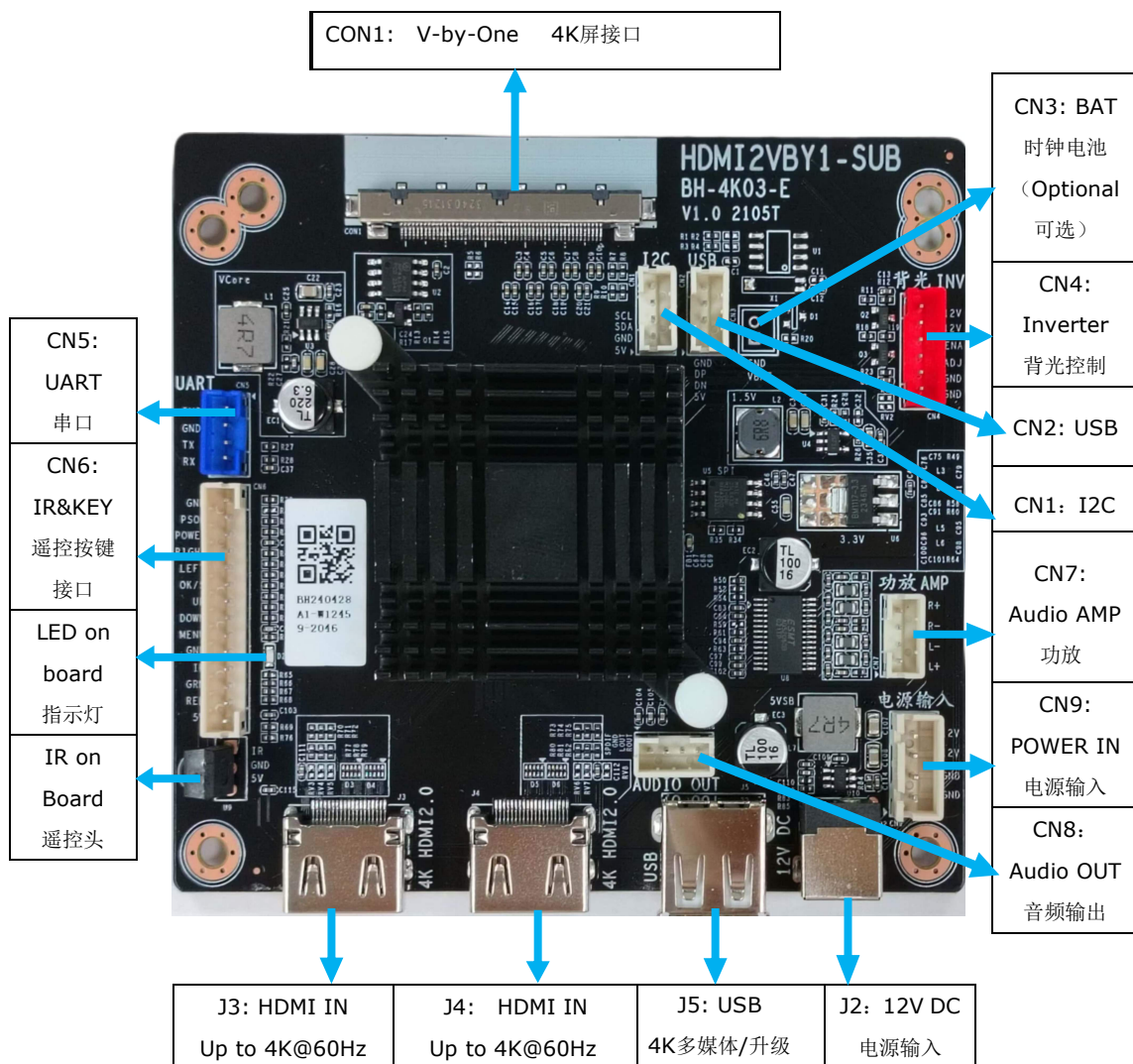
BH-4K03-E is a multi-function 4K driver board, with 8 lane v-by-one output for Large Size 4K@60Hz panel, it supports HDMI2.0 input. It supports USB multimedia up to 4K@60Hz, is suitable for digital signage application.

是一款多功能4K显示板卡，可直接驱动8 lane V-by-one 4K 60Hz大尺寸面板。支持2路HDMI2.0输入（支持4K点对点显示），支持4K多媒体播放,适用于数字标牌等商用显示。

2. FUNCTION LAYOUT （产品外观）

NOTE: The optional connectors and terminals are marked with “*”.

INTERFACE VIEW OF BH-4K03-E （内部接口示意图）



3. FEATURES

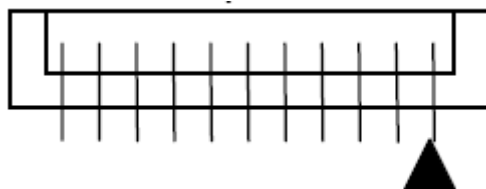
3.1 Main Features Overview (主要特性)

CHIPSET (主芯片)	Mstar	
MARKET (目标应用)	4K Monitor; Education whiteboard; Medical Monitor;	
OSD LANGUAGE (OSD语言)	English, Multi-Language, 英文, 多国语言	
PANEL (面板)	Panel Type(类型)	8 lane V-By-One 4K UHD@60Hz
	Resolution (分辨率)	Up to 3840x2160
VIDEO INPUT (视频信号输入)	HDMI	480i, 480p, 576i, 576p, 720p, 1080i, 1080p, 4Kx2K@60Hz
POWER REQUIREMENT	12V	
POWER CONSUMPTION	Standby(待机)	≤ 0.5W
POWER TO TCON (屏TCON供电)	To Panel (驱屏电压)	12V
COMB FILTER (梳状滤波器)	3D	
DE-INTERLACE (隔逐行转换)	3D	
KEY FUNCTION (按键功能)	MENU, UP, Down, VOL+, VOL-, INPUT, POWER, ECO 菜单, 上, 下, 音量+, 音量-, 信号源, 电源, 节能	
Note: Licenses involved in specifications above are supposed to be obtained by customers themselves. 注意: 以上规格涉及License部分需要客户自己根据需要获取。		

4. INTERFACE DIFINITION (接口定义)

All connecting plug-ins recognize tacitly the square pin as No.1 pin. The pin definition also refers to PCBA bottom silkscreen. No.1 pin of 2.0/2.54mm pitch sockets show as below picture:

Pin脚顺序, PCB封装方脚均表示第1脚。2.0/2.54mm间距插座缺口朝上时, 最左边为第1脚, 如下图所示:



◆ CON1 (51PIN/0.5): V-By-One TO PANEL CONNECTOR

- FI-RE51S-HF (manufactured by JAE)
- Mating Connector: FI-R51HL (JAE) or compatible

NO.	SYMBOL	DESCRIPTION	NO.	SYMBOL	DESCRIPTION
51	12V	Power Supply +12.0V	25	GND	Ground
50	12V	Power Supply +12.0V	24	Rx0n	V-by-One HS DATA LANE0
49	12V	Power Supply +12.0V	23	Rx0p	
48	12V	Power Supply +12.0V	22	GND	Ground
47	12V	Power Supply +12.0V	21	Rx1n	V-by-One HS DATA LANE1
46	12V	Power Supply +12.0V	20	Rx1p	
45	12V	Power Supply +12.0V	19	GND	Ground
44	12V	Power Supply +12.0V	18	Rx2n	V-by-One HS DATA LANE2
43	NC	No Connection	17	Rx2p	
42	GND	Ground	16	GND	Ground
41	GND	Ground	15	Rx3n	V-by-One HS DATA LANE3
40	GND	Ground	14	Rx3p	
39	GND	Ground	13	GND	Ground
38	NC	No Connection	12	Rx4n	V-by-One HS DATA LANE4
37	NC		11	Rx4p	
36	NC		10	GND	Ground
35	NC		9	Rx5n	V-by-One HS DATA LANE5
34	PNL_SDA	PANEL I2C Data Signal	8	Rx5p	
33	PNL_SCL	PANEL I2C Clock Signal	7	GND	Ground
32	NC	No Connection	6	Rx6n	V-by-One HS DATA LANE6
31	NC		5	Rx6p	
30	NC		4	GND	Ground
29	NC		3	Rx7n	V-by-One HS DATA LANE7
28	NC		2	Rx7p	
27	HTPDN	Hot Plug Detect	1	GND	Ground
26	LOCKN	Lock Detect	-	-	-

◆ **CN4 (6PIN/2.0): INVERTER CONNECTOR** 背光控制接口

NO.	SYMBOL	DESCRIPTION
1	GND	Ground
2	GND	Ground
3	ADJ	Backlight brightness adjust(0V-3V, 默认3.3V最亮)
4	ON/OFF	Backlight Control(H:ON, L:OFF)
5	12V	+12V Power Supply
6	12V	+12V Power Supply

◆ **CN9 (4PIN/2.5): POWER IN CONNECTOR** 电源输入接口

NO.	SYMBOL	DESCRIPTION
1	GND	Ground
2	GND	

3	12V	+12V Power Supply
4	12V	+12V Power Supply

◆ **CN1 (4PIN/2.0): I2C CONNECTOR** I2C接口

NO.	SYMBOL	DESCRIPTION
1	5V	5V power supply
2	GND	Ground
3	SDA	IIC Data Signal
4	SCL	IIC Clock Signal

- For digital light sensitive sensor. 可用于连接数字感光模块

◆ **CN2 (4PIN/2.0): USB CONNECTOR** 内部USB接口

NO.	SYMBOL	DESCRIPTION
1	5V	5V power supply
2	DN	USB Data
3	DP	
4	GND	Ground

◆ **CN3 (2PIN/2.0): RTC BAT CONNECTOR** 实时时钟电池接口

NO.	SYMBOL	DESCRIPTION
1	VBAT	Battery VCC power supply
2	GND	Ground

- For RTC application. 实时时钟电池接口 (选配功能)

◆ **CN6 (14PIN/2.0): IR&KEY BOARD CONNECTOR** 遥控按键接口

NO.	SYMBOL	DESCRIPTION
1	GND	Ground
2	PSON	POWER ON/OFF Control for Power Supply Module or ADC KEY7(ECO Key) 电源开关控制 或 节能键 (控制背光开关)
3	K6/Power	ADC KEY6 (Power Key default) 默认电源键
4	K5/Right	ADC KEY5 (Volume+ Key default) 默认音量加/右键
5	K4/Left	ADC KEY4 (Volume- Key default) 默认音量减/左键
6	K3/Source	ADC KEY3 (Source Key default) 默认输入源/确认键
7	K2/Up	ADC KEY2 (UP Key default) 默认向上键
8	K1/Down	ADC KEY1 (Down Key default) 默认向下键
9	K0/Menu	ADC KEY0 (Menu Key default) 默认菜单键
10	GND	Ground
11	IR	Remote control 红外遥控接收

12	GRN	Green indicator 绿色指示灯
13	RED	Red indicator 红色指示灯
14	5V	+5V power supply for IR 遥控接收头5V供电

◆ CN5 (4PIN/2.0): UART CONNECTOR 串口TTL接口

NO.	SYMBOL	DESCRIPTION
1	5VS	5V power Supply
2	GND	Ground
3	TX	UART Transmitter Signal
4	RX	UART Receiver Signal

-支持中控串口命令控制

◆ CN7 (4PIN/2.0): SPEAKER CONNECTOR 喇叭接口

NO.	SYMBOL	DESCRIPTION
1	L+	Audio Left Channel Output+ 左声道正输出
2	L-	Audio Left Channel Output- 左声道负输出
3	R-	Audio Right Channel Output- 右声道负输出
4	R+	Audio Right Channel Output+ 右声道正输出

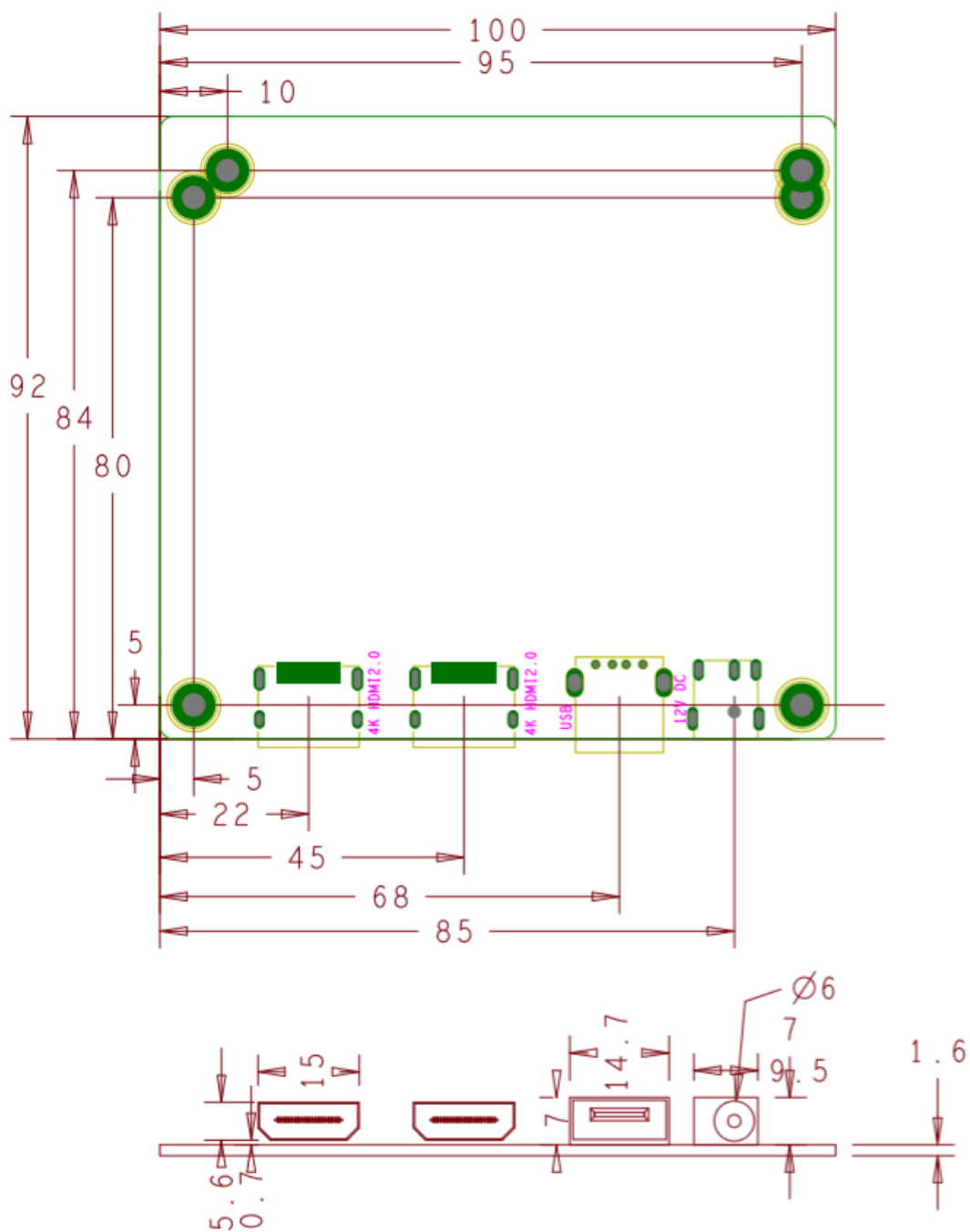
◆ CN8 (4PIN/2.0): SPEAKER CONNECTOR 喇叭接口

NO.	SYMBOL	DESCRIPTION
1	SPDIF	SPDIF Digital Audio Output 数字音频SPDIF输出
2	GND	Ground
3	LOUT	Audio Right Channel Line Output 模拟音频左声道输出
4	ROUT	Audio Right Channel Line Output 模拟音频右声道输出

-用于外接功放

5. PCB Dimension 尺寸图

The overall height of BH-4K03-E is 18 mm.



6. CONFIGURATION & GENERAL PRECAUTIONS

使用环境和注意事项

- Storage temperature: -10~60°C.
- 存储温度: -10~60°C。
- Operation temperature: 0~40°C.
- 工作温度: 0~40°C。
- Operating: 10% to 90% (Non-condensing, 无冷凝)
- 工作湿度: 10% ~ 90%
- Store: 5% to 95%
- 储存湿度: 5%~95%
- Operating: 10,000ft (max)
- 工作高度: 10,000ft (最大)
- Store: 20,000ft (max)
- 储存高度: 20,000ft (最大)
- Vibration (振动) 5-55Hz, 19.6m/s²(2G), 20minutes each along X, Y and Z axis.
- Protect the board from static electricity in case of damage to the IC.
- 请使板卡远离静电。
- Keep the board away from conductor when it is working.
- 请确保板卡工作时远离导体。
- Don't push or pull the connectors when the board is working.
- 板卡工作时请勿按压和扭曲。
- Don't press, distort or disassemble the board.
- 请勿拆解板卡。
- Clean the board with soft dry cloth when it's dirty.
- 如果板卡脏了, 请用干布擦拭。
- Don't wire in the board to power supply before panel is correctly connected.
- 正确接好驱屏线前请勿接通电源。
- Inner wires of the whole set should match reasonable, we suggest the LVDS twisted pair wire between the main board and panel must be tied up well and try to use shielding wire. If it's possible, try to put on the magnetic belt ring on the wire which near the board terminal, each connected wire try to not directly cross the PCB board, especially cross over from the main chips, avoid affecting the whole set EMC performance.
- 机内需合理布线, 芯片上方不建议走线, LVDS屏线必须使用双绞线并建议使用屏蔽网, 同时将地环锁死在PCB孔位上。

7. PACKING, SHIPPING & STORING (包装、运输、贮存)

7.1、Packing (包装)

Product name, part number, supplier's logo, QC stamp, Pb-free display and date must be printed on the package case.

包装箱上有产品名称、型号、厂家标识、厂家质量部门的检验合格证、制造日期等。

7.2、Shipping (运输)

This product can be transported through land, sea or air. Measures should be taken for water and

sun proof. Also, it should be handled with care.

适应于车、船、飞机运输，运输中应遮蓬、防晒、文明装卸。

7.3、Storing(贮存)

Please keep staying in the package case before using and keep away from hazardous gas, flammable or explosive substances and erosive chemical material. Avoid dramatic vibration or shock and strong magnetic field. The package cases should be racked 20cm above the ground and 50cm away from the wall, window, heat source or ventilation port. Generally the storage term of this product is 2 years. All the products should be double checked after that time.

产品未使用时应存放在包装箱内，仓库内不允许有有害气体，易燃，易爆的产品及有腐蚀性的化学物品，并且无强烈的机械振动，冲击和强磁场作用，包装箱应垫离地至少20cm高，距离墙壁、热源、窗口或空气入口至少50cm，在本规定条件下的贮存期一般为2年，超过2年后应重新进行检验。